

REMARKS

This Amendment is being filed in response to the Final Office Action mailed March 25, 2008, which has been reviewed and carefully considered. By means of the present amendment, independent claim 1 has been amended to place it in better form for appeal. Accordingly, entry of the present amendment and allowance of the present application in view of the amendments made above and the remarks to follow are respectfully requested.

In the Final Office Action, the Examiner objected to claim 1 for certain informalities. In response, claim 1 has been amended in accordance with the Examiner's suggestions. Accordingly, withdrawal of the objection to claim 1 is respectfully requested.

In the Final Office Action, claims 3 and 5-6 are objected to for being of improper dependent form for allegedly failing to further limit the subject matter of a previous claim. Applicants respectfully traverse and submit that claims 3 and 5-6 are in proper dependent form and do further limit the subject matter of claim 1. In particular, claims 3 includes features related to the thickness of the metallic structure, where such features are not

recited in claim 1; claim 5 includes various structures which are not recited in claim 1; and claim 6 recites matching patterns that are not recited in claim 1. Accordingly, claims 3 and 5-6 further limit the subject matter of claim 1, and withdrawal of the objection to claims 3 and 5-6 is respectfully requested.

In the Final Office Action, claim 1 is rejected under 35 U.S.C. §112, first paragraph as allegedly failing to comply with the written description requirement. Without agreeing with the position forwarded in the Final Office Action, and in the interest of advancing prosecution, independent claim 1 has been amended for better clarity and to better conform to the specification. Accordingly, withdrawal of the rejection to claim 1 is respectfully requested.

In the Final Office Action, claims 1, 3 and 6 are rejected under 35 U.S.C. §112, second paragraph as allegedly indefinite. Without agreeing with the Examiner, and in the interest of advancing prosecution, claim 1 has been amended to remove the alleged informalities noted by the Examiner. It is respectfully submitted that the rejection of claims 1, 3 and 6 has been overcome and an indication as such is respectfully requested.

In the Final Office Action, claims 1, 3 and 5-6 are rejected under 35 U.S.C. §103(a) as allegedly unpatentable over EP 0 888 035 (Hosokawa) in view of U.S. Patent No. 6,133,581 (Terao). It is respectfully submitted that Claims 1, 3, and 5-6 are patentable over Hosokawa and Terao for at least the following reasons.

Hosokawa shows in FIGs 1-2 a wiring layer 5 formed in a planarization layer 6 formed on a substrate 1. Assuming arguendo that the Hosokawa planarization layer 6 is analogous to the substrate as recited in independent claim 1, it is respectfully submitted that FIGs 1-2 show that the wiring layer 5 has a width which is more than 20% of portions of the surface of the planarization layer 6 that are in contact with the lower electrode 2. Terao is cited to allegedly show that "a width of the metallic structure that obstructs the light from the observer is not more than 10% of the surface of the substrate," as recited in independent claim 1.

Terao is directed to an organic light-emitting device shown in FIG 1 which is formed of a transparent substrate 1 having conductive strips 2b formed on the transparent substrate 1. Transparent conductors 2a cover the conductive strips 2b, and an

organic film layer 3 is formed on the transparent conductors 2a. and cathodes formed on the organic film layer. An organic film laminate 3 is formed on the organic film layer 3.

Assuming, arguendo, that the dimensions of Terao recited in the paragraph spanning pages 7-8 of the Final Office Action, disclose or suggest that the conductive strips 2b cover 10% or less of the surface of the substrate 1, the Terao conductive strips 2b are formed on the transparent substrate 1, as clearly shown in FIG 1 and recited on column 6, line 17..

In stark contrast, the present invention as recited in independent claim 1, amongst other patentable elements requires (illustrative emphasis provided):

a metallic structure incorporated into the substrate, ...

wherein a width of the metallic structure that obstructs the light from the observer is not more than 10% of the surface of the substrate.

These features are nowhere taught or suggested in Hosokawa, Terao and combination thereof. At best, assuming the Examiner's allegations are correct, the combination of Hosokawa and Terao discloses conductors formed in and on a substrate, where the conductors formed on the substrate cover 10% or less of the surface

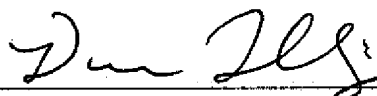
of the substrate.

Accordingly, it is respectfully submitted that independent claim 1 should be allowable, and allowance thereof is respectfully requested. In addition, it is respectfully submitted that claims 3 and 5-6 should also be allowed at least based on their dependence from amended independent claim 1.

In addition, Applicants deny any statement, position or averment of the Examiner that is not specifically addressed by the foregoing argument and response. Any rejections and/or points of argument not addressed would appear to be moot in view of the presented remarks. However, the Applicants reserve the right to submit further arguments in support of the above stated position, should that become necessary. No arguments are waived and none of the Examiner's statements are conceded.

In view of the above, it is respectfully submitted that the present application is in condition for allowance, and a Notice of Allowance is earnestly solicited.

Respectfully submitted,

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May 23, 2008

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